

**Electronic Patent Application Fee Transmittal**

<b>Application Number:</b>	10502412			
<b>Filing Date:</b>	23-Jul-2004			
<b>Title of Invention:</b>	Process for production of pressure-sensitive adhesive moldings comprising crosslinked polymers as the main component			
<b>First Named Inventor/Applicant Name:</b>	Takashi Yasukochi			
<b>Filer:</b>	Kathleen A. Tyrrell/Deborah Ehret			
<b>Attorney Docket Number:</b>	KUZ-0018			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
Claims in excess of 20	1615	6	50	300
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension - 1 month with \$0 paid	1251	1	120	120
<b>Miscellaneous:</b>				
Request for continued examination	1801	1	810	810
<b>Total in USD (\$)</b>				<b>1230</b>